

# PRELIMINARY DATASHEET

## SISD0800ED120i20

ED-Type phase leg IGBT module



**$V_{CE} = 1200\text{ V}$**

**$I_C = 2 \times 800\text{ A}$**

- *i20* ultra-low loss fine pattern Trench IGBT chipset
- Si<sub>3</sub>N<sub>4</sub> Ceramic and Cu baseplate for leading low thermal resistance
- Industry standard package

### Maximum ratings<sup>1</sup>

| PARAMETER                      | SYMBOL              | CONDITIONS   | MIN | MAX                    | UNIT                  |
|--------------------------------|---------------------|--|-----|------------------------|-----------------------|
| Collector-emitter voltage      | $V_{CES}$           | $V_{GE} = 0\text{ V}$ , $T_{vj} = 25\text{ °C}$                                      |     | 1200                   | V                     |
| Implemented nominal current    | $I_C$               | $T_C = 120\text{ °C}$ , $T_{vj} = 175\text{ °C}$                                     |     | 800                    | A                     |
| Peak collector current         | $I_{CM}$            | $t_p = 1\text{ ms}$  |     | 1500                   | A                     |
| Gate-emitter voltage           | $V_{GES}$           |  | -20 | 20                     | V                     |
| Total power dissipation        | $P_{tot}$           | $T_C = 25\text{ °C}$ , $T_{vj} = 175\text{ °C}$ , per switch                         |     | 3750                   | W                     |
| DC forward current             | $I_F$               |  |     | 750                    | A                     |
| Peak forward current           | $I_{FRM}$           | $t_p = 1\text{ ms}$  |     | 1500                   | A                     |
| Surge current                  | $I_{FSM}$<br>$I^2t$ | $V_R = 0\text{ V}$ , $T_{vj} = 150\text{ °C}$ , $t_p = 10\text{ ms}$ , half-sinewave |     | 2750<br>37500          | A<br>A <sup>2</sup> s |
| Isolation voltage              | $V_{isol}$          | 1 min, $f = 50\text{ Hz}$  |     | 3400                   | V                     |
| Junction operating temperature | $T_{vj(op)}$        |  | -40 | 175 <sup>2</sup>       | °C                    |
| Case temperature               | $T_C$               |  | -40 | 125 <sup>3</sup> / 150 | °C                    |
| Storage temperature            | $T_{stg}$           |  | -40 | 125                    | °C                    |
| Mounting torques <sup>4</sup>  | $M_S$               | Base-heatsink, M5 screws   | 3   | 6                      | Nm                    |
|                                | $M_{t1}$            | Main terminals, M6 screws  | 3   | 6                      | Nm                    |

<sup>1</sup> Maximum rated values indicate limits beyond which damage to the device may occur per IEC 60747

<sup>2</sup>  $T_{vj(op)} > 150\text{ °C}$  allowed for overload conditions, in maximum for 60s and less than 20% of operation time

<sup>3</sup> For UL1557 compliance  $T_{Cmax}$  must be limited to 125°C

<sup>4</sup> For details, please refer to the mounting instructions

## IGBT<sup>5</sup>

| PARAMETER   | SYMBOL        | CONDITIONS   | MIN                          | TYP  | MAX | UNIT          |
|---|---------------|--|------------------------------|------|-----|---------------|
| Collector(-emitter) breakdown voltage             | $V_{(BR)CES}$ | $V_{GE} = 0\text{ V}$ , $I_C = 10\text{ mA}$ , $T_{vj} = 25^\circ\text{C}$   | 1200                         |      |     | V             |
| Collector-emitter saturation voltage <sup>6</sup> | $V_{CEsat}$   | $I_C = 750\text{ A}$ , $V_{GE} = 15\text{ V}$  | $T_{vj} = 25^\circ\text{C}$  | 1.65 | 2   | V             |
|   |               |  | $T_{vj} = 125^\circ\text{C}$ | 1.95 |     | V             |
|   |               |  | $T_{vj} = 175^\circ\text{C}$ | 2.1  |     | V             |
| Collector cut-off current                         | $I_{CES}$     | $V_{CE} = 1200\text{ V}$ , $V_{GE} = 0\text{ V}$   | $T_{vj} = 25^\circ\text{C}$  |      | 1   | mA            |
|   |               |  | $T_{vj} = 125^\circ\text{C}$ | 1    |     | mA            |
|   |               |  | $T_{vj} = 175^\circ\text{C}$ | 20   |     | mA            |
| Gate leakage current                              | $I_{GES}$     | $V_{CE} = 0\text{ V}$ , $V_{GE} = \pm 20\text{ V}$   | -0.5                         |      | 0.5 | $\mu\text{A}$ |
| Gate-emitter threshold voltage                    | $V_{GE(th)}$  | $I_C = 37.5\text{ mA}$ , $V_{CE} = V_{GE}$ , $T_{vj} = 25^\circ\text{C}$   | 5                            | 6.2  | 7.5 | V             |
| Gate charge                                       | $Q_G$         | $I_C = 750\text{ A}$ , $V_{CE} = 600\text{ V}$ , $V_{GE} = -15\text{ V} \dots 15\text{ V}$   |                              | 5.3  |     | $\mu\text{C}$ |
| Input capacitance                                 | $C_{ies}$     | $V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$ , $f = 100\text{ kHz}$ , $T_{vj} = 25^\circ\text{C}$  |                              | 44   |     | nF            |
| Output capacitance                                | $C_{oes}$     |  |                              | 3.9  |     | nF            |
| Reverse transfer capacitance                      | $C_{res}$     |  |                              | 2.1  |     | nF            |
| Internal gate resistor                            | $R_{Gint}$    | Per switch   |                              | 1.2  |     | $\Omega$      |
| Turn-on delay time                                | $t_{d(on)}$   | $V_{CC} = 600\text{ V}$ , $I_C = 750\text{ A}$ ,<br>$R_G = 0.47\ \Omega$ , $V_{GE} = \pm 15\text{ V}$ ,<br>$L_S = 30\text{ nH}$ , inductive load         | $T_{vj} = 25^\circ\text{C}$  | 120  |     | ns            |
|   |               |  | $T_{vj} = 125^\circ\text{C}$ | 145  |     | ns            |
|   |               |  | $T_{vj} = 175^\circ\text{C}$ | 155  |     | ns            |
| Rise time   | $t_r$         |  | $T_{vj} = 25^\circ\text{C}$  | 70   |     | ns            |
|   |               |  | $T_{vj} = 125^\circ\text{C}$ | 80   |     | ns            |
|   |               |  | $T_{vj} = 175^\circ\text{C}$ | 80   |     | ns            |
| Turn-off delay time                               | $t_{d(off)}$  | $V_{CC} = 600\text{ V}$ , $I_C = 750\text{ A}$ ,<br>$R_G = 1.5\ \Omega$ , $V_{GE} = \pm 15\text{ V}$ ,<br>$L_S = 30\text{ nH}$ , inductive load          | $T_{vj} = 25^\circ\text{C}$  | 550  |     | ns            |
|   |               |  | $T_{vj} = 125^\circ\text{C}$ | 650  |     | ns            |
|   |               |  | $T_{vj} = 175^\circ\text{C}$ | 690  |     | ns            |
| Fall time   | $t_f$         |  | $T_{vj} = 25^\circ\text{C}$  | 165  |     | ns            |
|   |               |  | $T_{vj} = 125^\circ\text{C}$ | 285  |     | ns            |
|   |               |  | $T_{vj} = 175^\circ\text{C}$ | 325  |     | ns            |
| Turn-on switching energy                          | $E_{on}$      | $V_{CC} = 600\text{ V}$ , $I_C = 750\text{ A}$ ,<br>$R_G = 0.47\ \Omega$ , $V_{GE} = \pm 15\text{ V}$ ,<br>$L_S = 30\text{ nH}$ , inductive load         | $T_{vj} = 25^\circ\text{C}$  | 33   |     | mJ            |
|   |               |  | $T_{vj} = 125^\circ\text{C}$ | 82   |     | mJ            |
|   |               |  | $T_{vj} = 175^\circ\text{C}$ | 115  |     | mJ            |
| Turn-off switching energy                         | $E_{off}$     | $V_{CC} = 600\text{ V}$ , $I_C = 750\text{ A}$ ,<br>$R_G = 1.5\ \Omega$ , $V_{GE} = \pm 15\text{ V}$ ,<br>$L_S = 30\text{ nH}$ , inductive load          | $T_{vj} = 25^\circ\text{C}$  | 82   |     | mJ            |
|   |               |  | $T_{vj} = 125^\circ\text{C}$ | 110  |     | mJ            |
|   |               |  | $T_{vj} = 175^\circ\text{C}$ | 120  |     | mJ            |
| Short circuit current                             | $I_{sc}$      | $t_{pcc} \leq 10\ \mu\text{s}$ , $V_{GE} = 15\text{ V}$ , $T_{vj} = 175^\circ\text{C}$ ,<br>$V_{CC} = 800\text{ V}$ , $V_{CEM\ Chip} \leq 1200\text{ V}$ |                              | 2000 |     | A             |

<sup>5</sup> Characteristic values according to IEC 60747-9

<sup>6</sup> Collector-emitter saturation voltage is given at chip-level



## Diode<sup>7</sup>

| PARAMETER                     | SYMBOL    | CONDITIONS   |                                       | MIN | TYP  | MAX | UNIT          |
|-------------------------------|-----------|--|---------------------------------------|-----|------|-----|---------------|
| Forward voltage <sup>8</sup>  | $V_F$     | $I_F = 750 \text{ A}$  | $T_{vj} = 25 \text{ }^\circ\text{C}$  |     | 2    | 2.5 | V             |
|                               |           |  | $T_{vj} = 125 \text{ }^\circ\text{C}$ |     | 2.15 |     | V             |
|                               |           |  | $T_{vj} = 175 \text{ }^\circ\text{C}$ |     | 2.15 |     | V             |
| Peak reverse recovery current | $I_{RM}$  | $V_R = 600 \text{ V}$ , $I_F = 750 \text{ A}$ ,<br>$di/dt = 9100 \text{ A}/\mu\text{s}$ (175°C),<br>$R_G = 0.47 \text{ } \Omega$ , $V_{GE} = \pm 15 \text{ V}$ ,<br>$L_s = 30 \text{ nH}$ , inductive load | $T_{vj} = 25 \text{ }^\circ\text{C}$  |     | 515  |     | A             |
|                               |           |  | $T_{vj} = 125 \text{ }^\circ\text{C}$ |     | 590  |     | A             |
|                               |           |  | $T_{vj} = 175 \text{ }^\circ\text{C}$ |     | 610  |     | A             |
| Recovery charge               | $Q_{rr}$  |  | $T_{vj} = 25 \text{ }^\circ\text{C}$  |     | 60   |     | $\mu\text{C}$ |
|                               |           |  | $T_{vj} = 125 \text{ }^\circ\text{C}$ |     | 110  |     | $\mu\text{C}$ |
|                               |           |  | $T_{vj} = 175 \text{ }^\circ\text{C}$ |     | 145  |     | $\mu\text{C}$ |
| Reverse recovery time         | $t_{rr}$  |  | $T_{vj} = 25 \text{ }^\circ\text{C}$  |     | 240  |     | ns            |
|                               |           |  | $T_{vj} = 125 \text{ }^\circ\text{C}$ |     | 760  |     | ns            |
|                               |           |  | $T_{vj} = 175 \text{ }^\circ\text{C}$ |     | 980  |     | ns            |
| Reverse recovery energy       | $E_{rec}$ |  | $T_{vj} = 25 \text{ }^\circ\text{C}$  |     | 30   |     | mJ            |
|                               |           |  | $T_{vj} = 125 \text{ }^\circ\text{C}$ |     | 45   |     | mJ            |
|                               |           |  | $T_{vj} = 175 \text{ }^\circ\text{C}$ |     | 55   |     | mJ            |

## Package properties<sup>9</sup>

| PARAMETER                                 | SYMBOL             | CONDITIONS       |                                       | MIN | TYP   | MAX | UNIT       |
|---|--------------------|------------------|---------------------------------------|-----|-------|-----|------------|
| IGBT thermal resistance junction to case  | $R_{th(j-c)IGBT}$  | Per switch       |                                       |     | 0.028 |     | K/W        |
| Diode thermal resistance junction to case | $R_{th(j-c)Diode}$ |                  |                                       |     | 0.045 |     | K/W        |
| IGBT thermal resistance case to heatsink  | $R_{th(c-s)IGBT}$  | IGBT per switch  |                                       |     | 0.030 |     | K/W        |
| Diode thermal resistance case to heatsink | $R_{th(c-s)Diode}$ | diode per switch |                                       |     | 0.036 |     | K/W        |
| Comparative tracking index                | CTI                |                  |                                       | 200 |       |     |            |
| Module stray inductance                   | $L_{sCE}$          | Per switch       |                                       |     | 20    |     | nH         |
| Resistance, terminal chip                 | $R_{CC+EE}$        | Per switch       | $T_{vj} = 25 \text{ }^\circ\text{C}$  |     | 0.9   |     | m $\Omega$ |
|   |                    |                  | $T_{vj} = 125 \text{ }^\circ\text{C}$ |     | 1.25  |     | m $\Omega$ |
|   |                    |                  | $T_{vj} = 175 \text{ }^\circ\text{C}$ |     | 1.4   |     | m $\Omega$ |
| Maximum RMS DC-Terminal current           | $I_{Term RMS}$     |                  | $T_{Terminal} = 90^\circ\text{C}$     |     | 580   |     | A          |
|   |                    |                  | $T_{Terminal} = 105^\circ\text{C}$    |     | 565   |     | A          |

<sup>7</sup> Characteristic values according to IEC 60747-2

<sup>8</sup> Forward voltage is given at chip-level

<sup>9</sup> Package and mechanical properties according to IEC 60747-15



## Mechanical properties

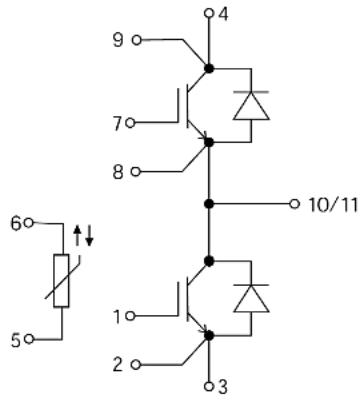
| PARAMETER                 | SYMBOL         | CONDITIONS                              |                       | MIN           | TYP | MAX | UNIT            |
|---------------------------|----------------|---|-----------------------|---------------|-----|-----|-----------------|
| Dimensions                | L x W x H      | Typical                                 |                       | 152 x 62 x 17 |     |     | mm <sup>3</sup> |
| Clearance distance in air | d <sub>a</sub> | According to IEC 60664-1 and EN 50124-1 | Terminal to base:     | 12.5          |     |     | mm              |
|                           |                |   | Terminal to terminal: | 10            |     |     | mm              |
| Surface creepage distance | d <sub>s</sub> | According to IEC 60664-1 and EN 50124-1 | Terminal to base:     | 14.5          |     |     | mm              |
|                           |                |   | Terminal to terminal: | 13            |     |     | mm              |
| Mass                      | m              |   |                       | 350           |     | g   |                 |

## NTC Thermistor

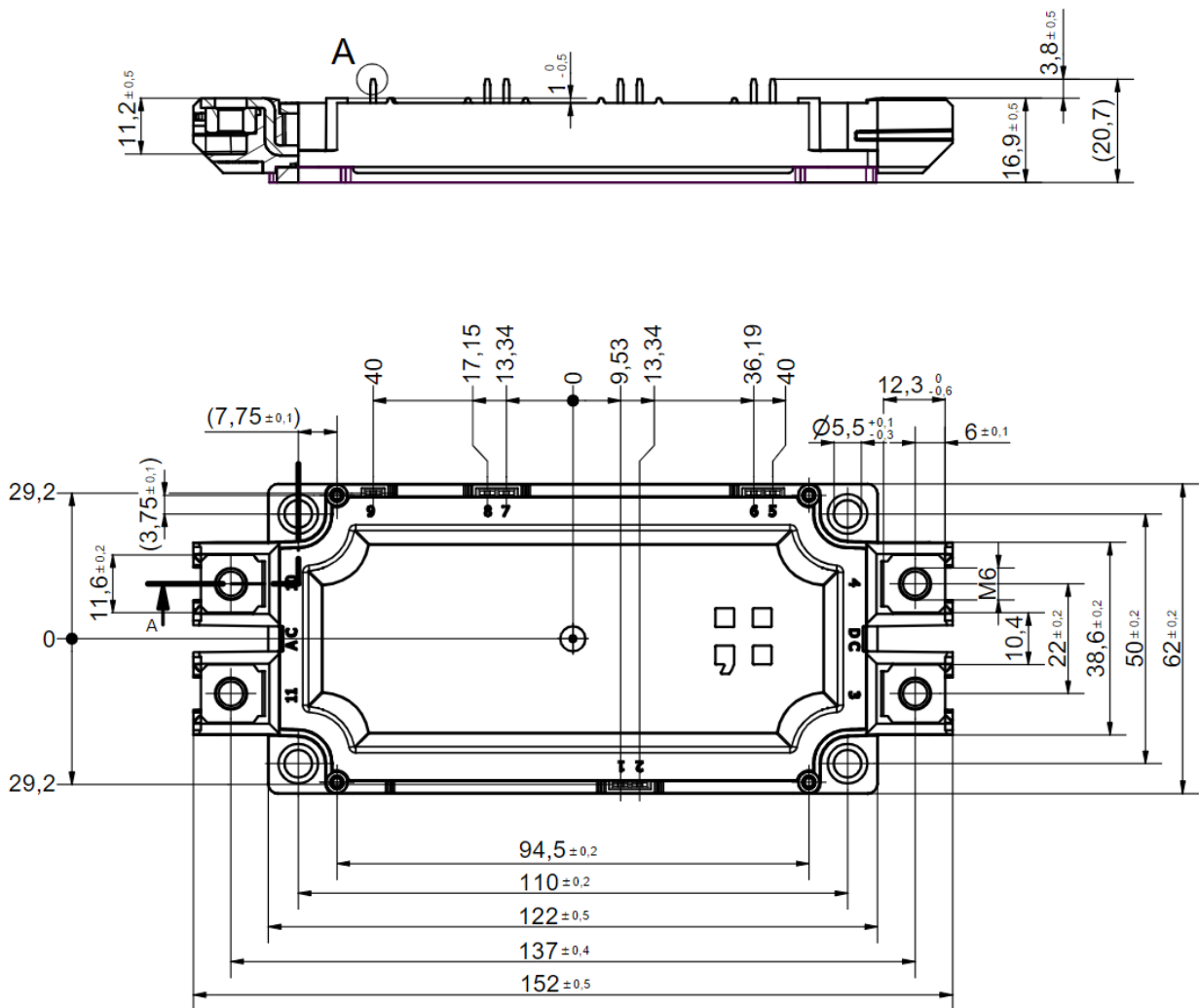
| PARAMETER        | SYMBOL              | CONDITIONS  |     | TYP  | MAX | UNIT |
|------------------|---------------------|---|-----|------|-----|------|
| Rated resistance | R <sub>25</sub>     | T <sub>c</sub> = 25 °C                                |     | 5    |     | kΩ   |
| R100             | R <sub>100</sub>    | T <sub>c</sub> = 100 °C                               | 468 |      | 518 | Ω    |
| B-value          | B <sub>25/50</sub>  | $R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298.15K))]$  |     | 3375 |     | K    |
| B-value          | B <sub>25/100</sub> | $R_2 = R_{25} \exp [B_{25/100}(1/T_2 - 1/(298.15K))]$ |     | 3433 |     | K    |



### Electrical configuration



### Outline drawing



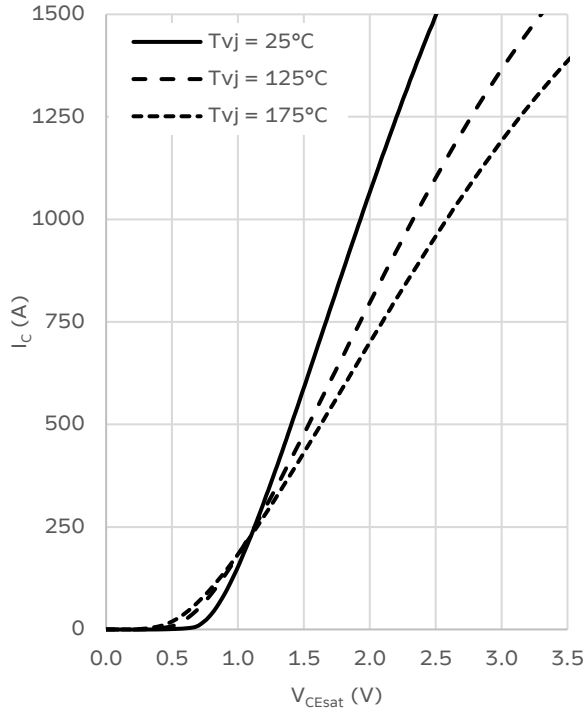
This is an electrostatic sensitive device.  
*This product has been designed and qualified for Industrial Level.*



## Characteristics

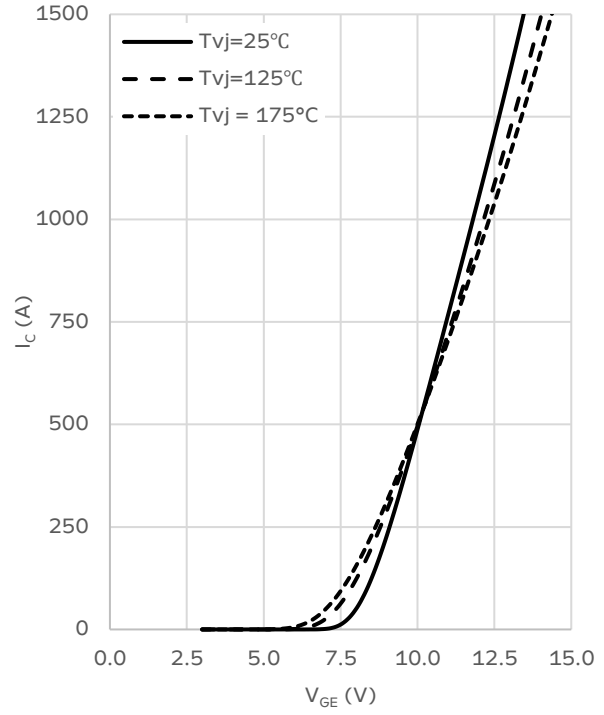
**IGBT on-state characteristics (typical)**

$I_C = f(V_{CE})$   
 $V_{GE} = 15\text{ V}$



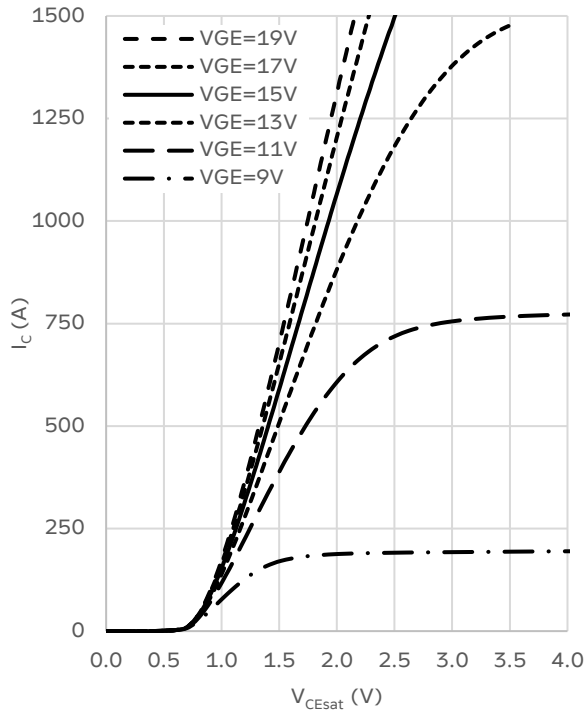
**IGBT transfer characteristics (typical)**

$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



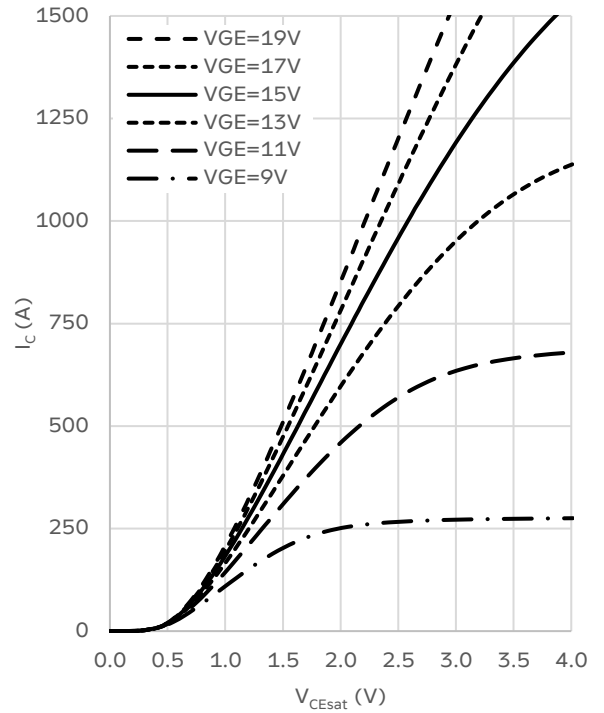
**IGBT output characteristics (typical)**

$I_C = f(V_{CE})$   
T<sub>vj</sub> = 25 °C



**IGBT output characteristics (typical)**

$I_C = f(V_{CE})$   
T<sub>vj</sub> = 175 °C

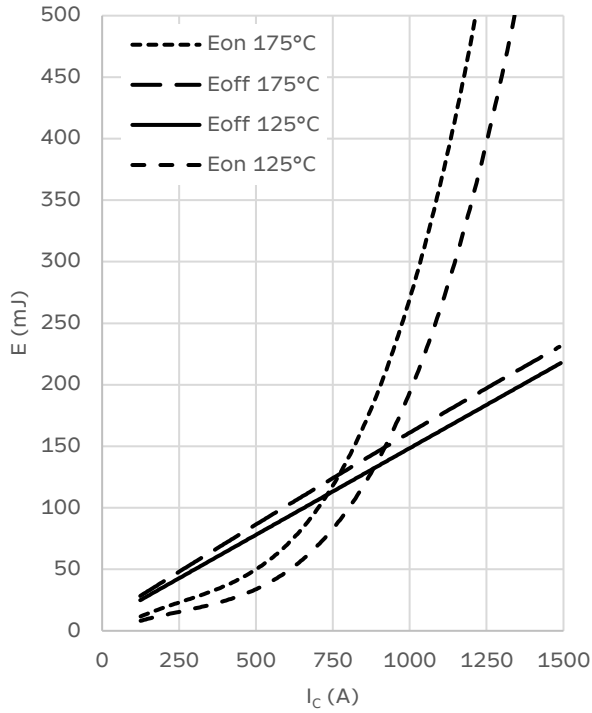




**IGBT switching losses (typical)**

$E = f(I_{CE})$

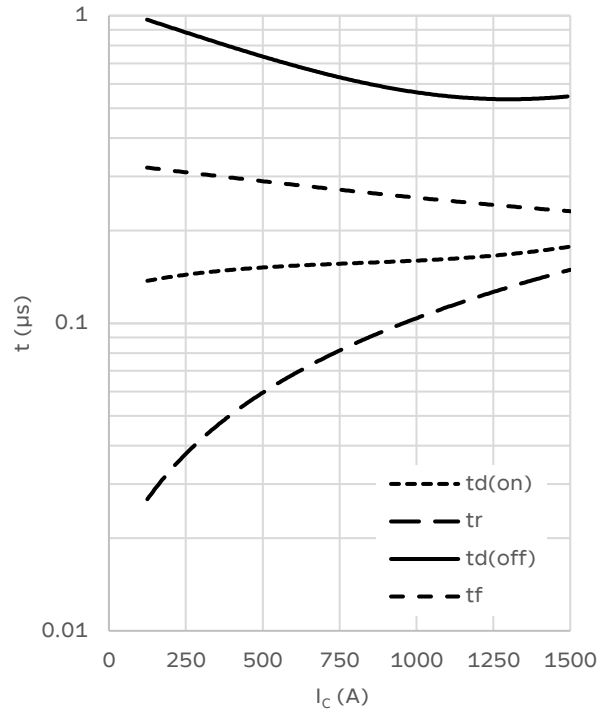
$V_{CE} = 600 \text{ V}, R_{Gon} = 0.47 \text{ } \Omega, R_{Goff} = 1.5 \text{ } \Omega, V_{GE} = -15/+15 \text{ V}$



**IGBT switching times (typical)**

$t = f(I_{CE}), T_{vj} = 175 \text{ } ^\circ\text{C}$

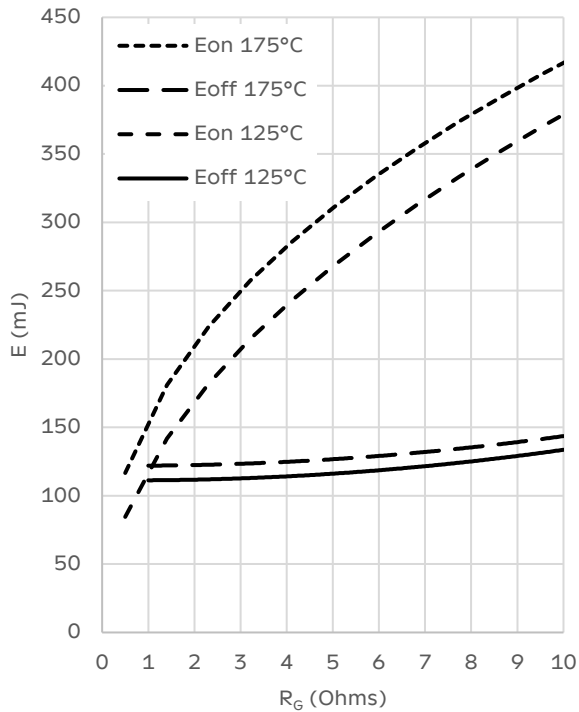
$V_{CE} = 600 \text{ V}, R_{Gon} = 0.47 \text{ } \Omega, R_{Goff} = 1.5 \text{ } \Omega, V_{GE} = -15/+15 \text{ V}$



**IGBT switching losses (typical)**

$E = f(R_G)$

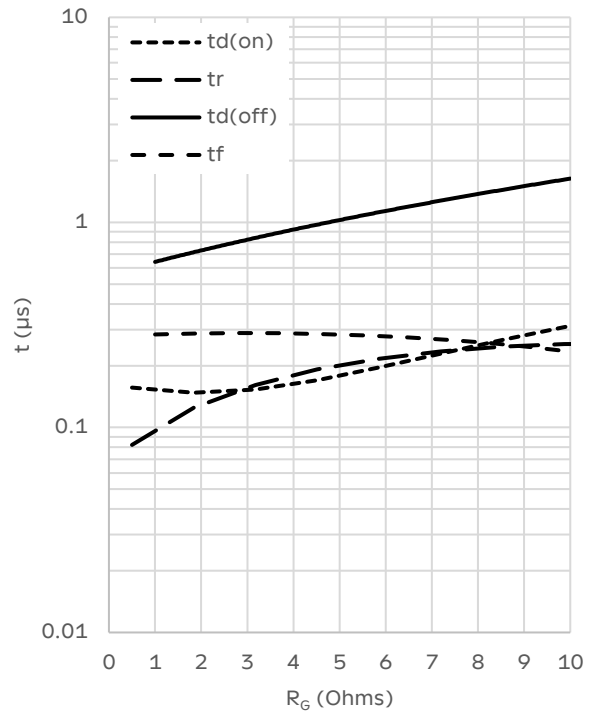
$V_{CE} = 600 \text{ V}, I_C = 750 \text{ A}, V_{GE} = -15/+15 \text{ V}$



**IGBT switching times (typical)**

$t = f(R_G), T_{vj} = 175 \text{ } ^\circ\text{C}$

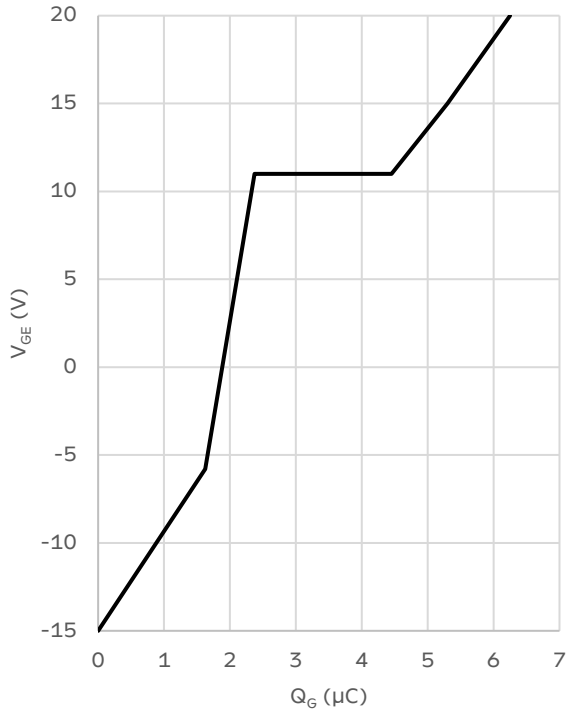
$V_{CE} = 600 \text{ V}, I_C = 750 \text{ A}, V_{GE} = -15/+15 \text{ V}$





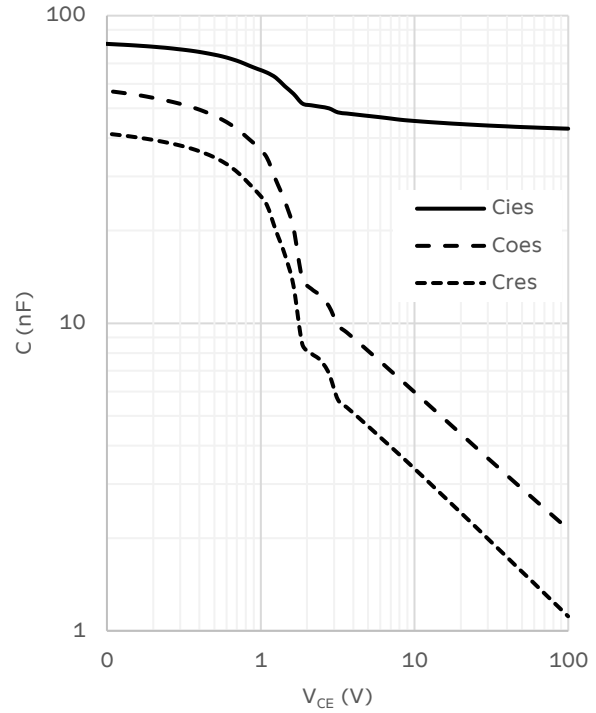
**IGBT gate charge (typical)**

$V_{GE} = f(Q_G)$ ,  $T_{vj} = 25\text{ °C}$   
 $V_{CE} = 600\text{ V}$ ,  $I_C = 750\text{ A}$



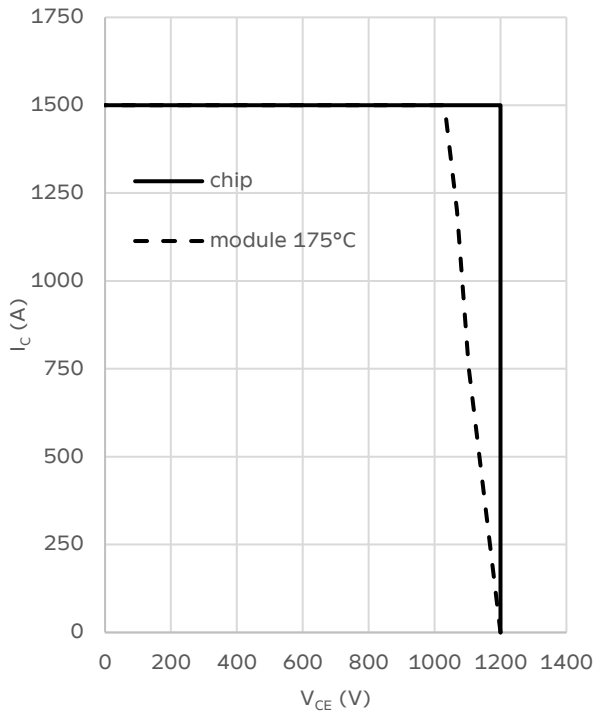
**Capacitance characteristics (typical)**

$C = f(V_{CE})$ ,  $T_{vj} = 25\text{ °C}$   
 $f = 100\text{ kHz}$ ,  $V_{GE} = 0\text{ V}$



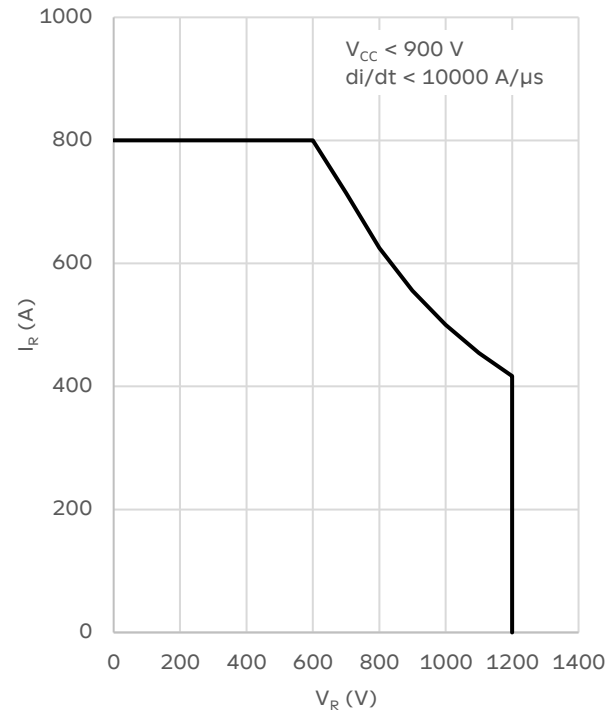
**IGBT RBSOA**

$I_C = f(V_{CEm})$   
 $R_{Goff} = 1.5\ \Omega$ ,  $V_{GE} = \pm 15\text{ V}$



**Diode SOA**

$T_{vj} \leq 175\text{ °C}$

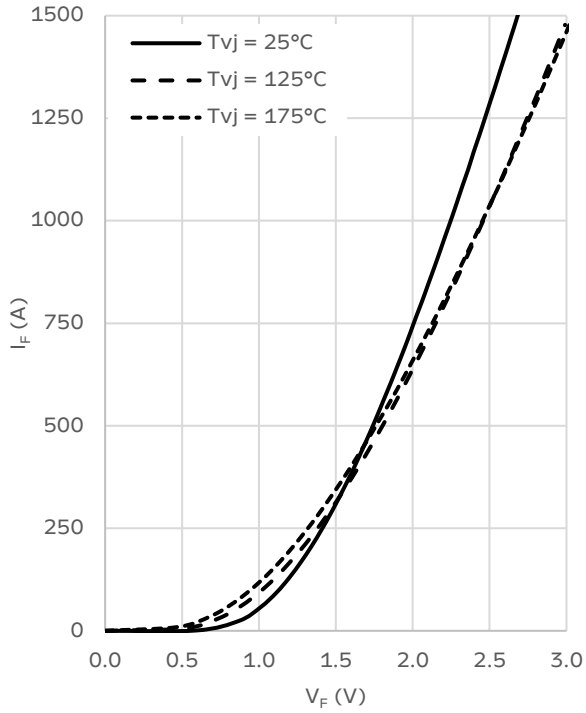






**Diode forward characteristic (typical)**

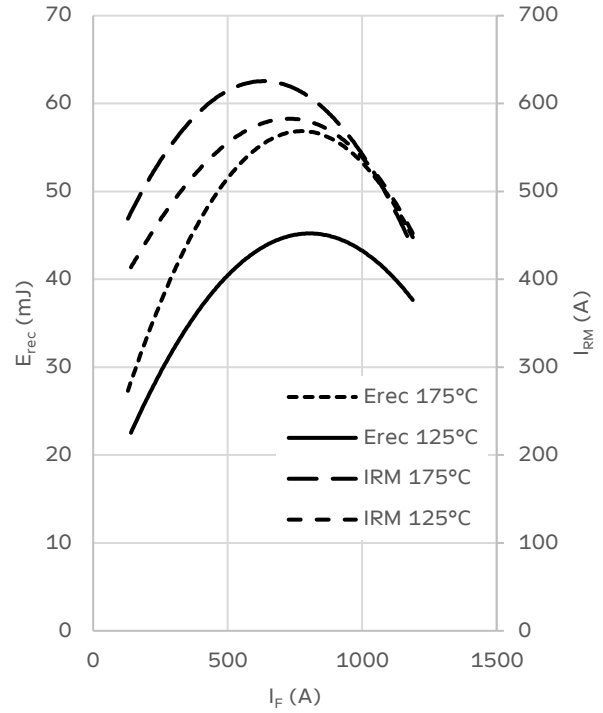
$I_F = f(V_F)$



**Diode switching characteristics (typical)**

$E_{rec} = f(I_F)$ ,  $I_{RM} = f(I_F)$

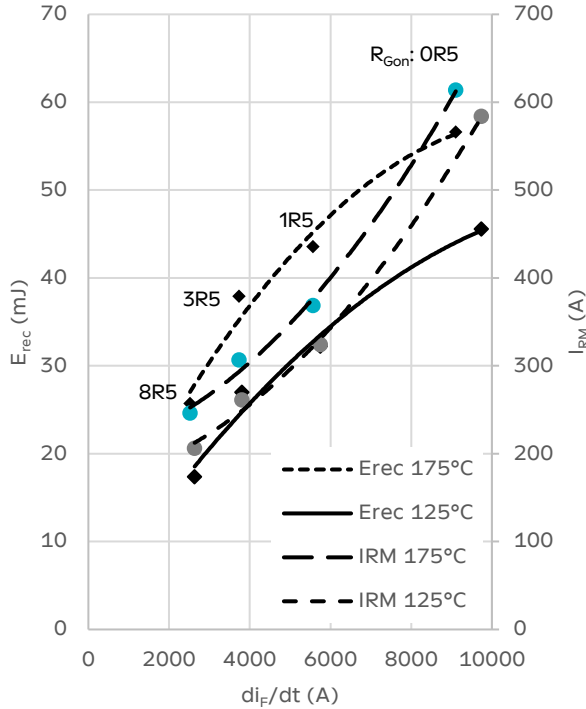
$V_{DC} = 600\text{ V}$ ,  $R_{Gon} = 0.47\ \Omega$  (IGBT),  $V_{GE} = -15/+15\text{ V}$  (IGBT)



**Diode switching characteristics (typical)**

$E_{rec} = f(di/dt)$ ,  $I_{RM} = f(di/dt)$

$V_{DC} = 600\text{ V}$ ,  $I_F = 750\text{ A}$ ,  $V_{GE} = -15/+15\text{ V}$  (IGBT)



**Thermal impedance (typical)**

$Z_{th(j-c)} = f(t)$

TBD